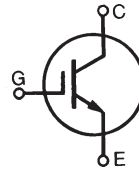


# HiPerFAST™ IGBT

## B2-Class High Speed IGBTs

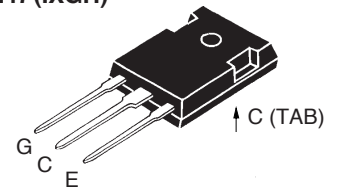
IXGH 32N90B2  
IXGT 32N90B2

$$\begin{aligned} V_{CES} &= 900 \text{ V} \\ I_{C25} &= 64 \text{ A} \\ V_{CE(sat)} &= 2.7 \text{ V} \\ t_{fi \text{ typ}} &= 150 \text{ ns} \end{aligned}$$

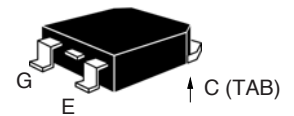


| Symbol  | Test Conditions   | Maximum Ratings  |                  |
|---|---|------------------|------------------|
| $V_{CES}$   | $T_J = 25^\circ\text{C}$ to $150^\circ\text{C}$   | 900              | V                |
| $V_{CGR}$   | $T_J = 25^\circ\text{C}$ to $150^\circ\text{C}$ ; $R_{GE} = 1 \text{ M}\Omega$  | 900              | V                |
| $V_{GES}$   | Continuous  | $\pm 20$         | V                |
| $V_{GEM}$   | Transient   | $\pm 30$         | V                |
| $I_{C25}$   | $T_C = 25^\circ\text{C}$ (limited by leads)   | 64               | A                |
| $I_{C110}$  | $T_C = 110^\circ\text{C}$   | 32               | A                |
| $I_{CM}$  | $T_C = 25^\circ\text{C}$ , 1 ms   | 200              | A                |
| <b>SSOA</b><br><b>(RBSOA)</b>   | $V_{GE} = 15 \text{ V}$ , $T_{VJ} = 125^\circ\text{C}$ , $R_G = 10 \Omega$<br>Clamped inductive load @ $\leq 600\text{V}$ | $I_{CM} = 64$    | A                |
| $P_C$   | $T_C = 25^\circ\text{C}$  | 300              | W                |
| $T_J$   |   | -55 ... +150     | $^\circ\text{C}$ |
| $T_{JM}$  |   | 150              | $^\circ\text{C}$ |
| $T_{stg}$   |   | -55 ... +150     | $^\circ\text{C}$ |
| Maximum lead temperature for soldering<br>1.6 mm (0.062 in.) from case for 10 s |   | 300              | $^\circ\text{C}$ |
| Plastic body for 10 s   |   | 260              | $^\circ\text{C}$ |
| $M_d$   | Mounting torque (TO-247)  | 1.13/10Nm/lb.in. |                  |
| <b>Weight</b>   |   | TO-247           | 6 g              |
|   |   | TO-268           | 4 g              |

TO-247 (IXGH)



TO-268 (IXGT)



G = Gate, C = Collector,  
E = Emitter, TAB = Collector

### Features

- High frequency IGBT
- High current handling capability
- MOS Gate turn-on  
- drive simplicity

### Applications

- PFC circuits
- Uninterruptible power supplies (UPS)
- Switched-mode and resonant-mode power supplies
- AC motor speed control
- DC servo and robot drives
- DC choppers

### Advantages

- High power density
- Very fast switching speeds for high frequency applications

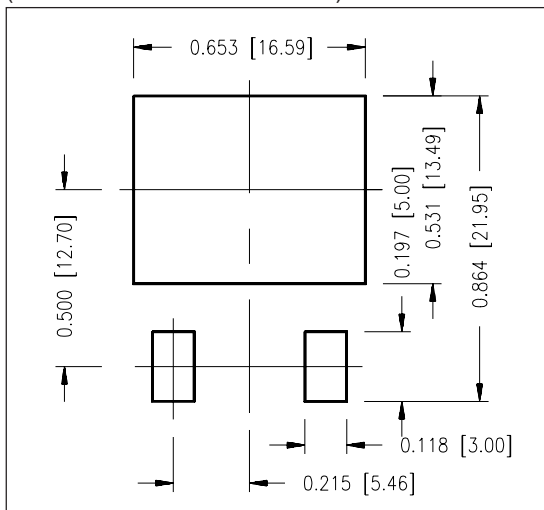
| Symbol        | Test Conditions                                      | Characteristic Values<br>( $T_J = 25^\circ\text{C}$ , unless otherwise specified) |      |                      |
|---------------|--|---|------|----------------------|
|               |  | min.  | typ. | max.                 |
| $V_{GE(th)}$  | $I_C = 250 \mu\text{A}$ , $V_{CE} = V_{GE}$          | 3.0   |      | 5.0 V                |
| $I_{CES}$     | $V_{CE} = V_{CES}$<br>$V_{GE} = 0 \text{ V}$         | $T_J = 25^\circ\text{C}$  |      | 50 $\mu\text{A}$     |
|               |  | $T_J = 150^\circ\text{C}$   |      | 750 $\mu\text{A}$    |
| $I_{GES}$     | $V_{CE} = 0 \text{ V}$ , $V_{GE} = \pm 20 \text{ V}$ |   |      | $\pm 100 \text{ nA}$ |
| $V_{CE(sat)}$ | $I_C = I_{C110}$ , $V_{GE} = 15 \text{ V}$           |   | 2.2  | 2.7 V                |
|               |  | $T_J = 125^\circ\text{C}$   | 2.1  | V                    |

| Symbol   | Test Conditions   | Characteristic Values<br>( $T_J = 25^\circ\text{C}$ , unless otherwise specified) |      |               |    |
|--|---|---|------|---------------|----|
|  |   | min.  | typ. | max.          |    |
| $g_{fs}$   | $I_C = I_{C110} A$ ; $V_{CE} = 10\text{ V}$ ,<br>Pulse test, $t \leq 300\ \mu\text{s}$ , duty cycle $\leq 2\%$  | 18  | 28   | S             |    |
| $C_{ies}$<br>$C_{oes}$<br>$C_{res}$  | $V_{CE} = 25\text{ V}$ , $V_{GE} = 0\text{ V}$ , $f = 1\text{ MHz}$   |   | 1790 | pF            |    |
|  |   |   | 121  | pF            |    |
|  |   |   | 49   | pF            |    |
| $Q_g$<br>$Q_{ge}$<br>$Q_{gc}$  | $I_C = I_{C110}$ , $V_{GE} = 15\text{ V}$ , $V_{CE} = 0.5 V_{CES}$  |   | 89   | nC            |    |
|  |   |   | 15   | nC            |    |
|  |   |   | 34   | nC            |    |
| $t_{d(on)}$<br>$t_{ri}$<br>$t_{d(off)}$<br>$t_{fi}$<br>$E_{off}$             | <b>Inductive load, <math>T_J = 25^\circ\text{C}</math></b><br>$I_C = I_{C110}$ , $V_{GE} = 15\text{ V}$<br>$V_{CE} = 720\text{ V}$ , $R_G = R_{off} = 5\ \Omega$    |   | 20   | ns            |    |
|  |   |   | 22   | ns            |    |
|  |   |   | 260  | 400           | ns |
|  |   |   | 150  |               | ns |
|  |   |   | 2.6  | 4.5           | mJ |
| $t_{d(on)}$<br>$t_{ri}$<br>$E_{on}$<br>$t_{d(off)}$<br>$t_{fi}$<br>$E_{off}$ | <b>Inductive load, <math>T_J = 125^\circ\text{C}</math></b><br>$I_C = I_{C110} A$ , $V_{GE} = 15\text{ V}$<br>$V_{CE} = 720\text{ V}$ , $R_G = R_{off} = 5\ \Omega$ |   | 20   | ns            |    |
|  |   |   | 22   | ns            |    |
|  |   |   | 0.5  |               | mJ |
|  |   |   | 3.8  |               | mJ |
|  |   |   | 360  |               | ns |
|  |   |   | 330  |               | ns |
|  |   | 5.75  |      | mJ            |    |
| $R_{thJC}$<br>$R_{thCS}$   | (TO-247)  |   |      | 0.42 KW<br>KW |    |
|  |   | 0.25  |      |               |    |

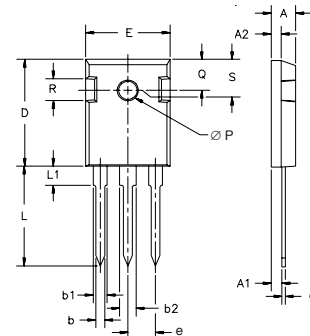
Note 1

Note 1:  $E_{on}$  measured with a DSEP 30-12A ultrafast diode clamp.

### Min. Recommended Footprint (Dimensions in inches and mm)

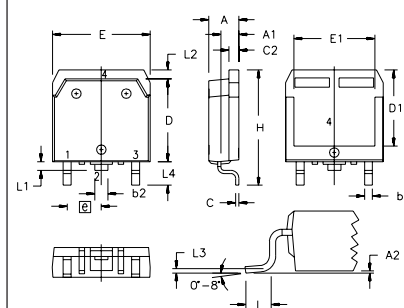


### TO-247 AD Outline



| Dim.           | Millimeter |       | Inches |       |
|----------------|------------|-------|--------|-------|
|                | Min.       | Max.  | Min.   | Max.  |
| A              | 4.7        | 5.3   | .185   | .209  |
| A <sub>1</sub> | 2.2        | 2.54  | .087   | .102  |
| A <sub>2</sub> | 2.2        | 2.6   | .059   | .098  |
| b              | 1.0        | 1.4   | .040   | .055  |
| b <sub>1</sub> | 1.65       | 2.13  | .065   | .084  |
| b <sub>2</sub> | 2.87       | 3.12  | .113   | .123  |
| C              | .4         | .8    | .016   | .031  |
| D              | 20.80      | 21.46 | .819   | .845  |
| E              | 15.75      | 16.26 | .610   | .640  |
| e              | 5.20       | 5.72  | 0.205  | 0.225 |
| L              | 19.81      | 20.32 | .780   | .800  |
| L1             |            | 4.50  |        | .177  |
| ∅P             | 3.55       | 3.65  | .140   | .144  |
| Q              | 5.89       | 6.40  | 0.232  | 0.252 |
| R              | 4.32       | 5.49  | .170   | .216  |
| S              | 6.15       | BSC   | .242   | BSC   |

### TO-268 Outline

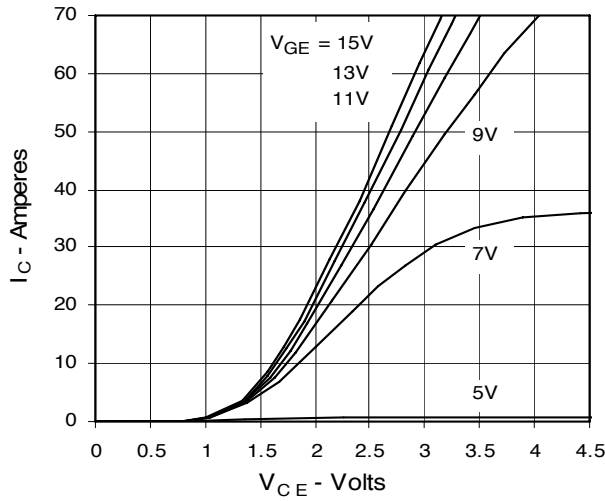


| SYM | INCHES   |      | MILLIMETERS |       |
|-----|----------|------|-------------|-------|
|     | MIN      | MAX  | MIN         | MAX   |
| A   | .193     | .201 | 4.90        | 5.10  |
| A1  | .106     | .114 | 2.70        | 2.90  |
| A2  | .001     | .010 | 0.02        | 0.25  |
| b   | .045     | .057 | 1.15        | 1.45  |
| b2  | .075     | .083 | 1.90        | 2.10  |
| C   | .016     | .026 | 0.40        | 0.65  |
| C2  | .057     | .063 | 1.45        | 1.60  |
| D   | .543     | .551 | 13.80       | 14.00 |
| D1  | .488     | .500 | 12.40       | 12.70 |
| E   | .624     | .632 | 15.85       | 16.05 |
| E1  | .524     | .535 | 13.30       | 13.60 |
| e   | .215 BSC |      | 5.45 BSC    |       |
| H   | .736     | .752 | 18.70       | 19.10 |
| L   | .094     | .106 | 2.40        | 2.70  |
| L1  | .047     | .055 | 1.20        | 1.40  |
| L2  | .039     | .045 | 1.00        | 1.15  |
| L3  | .010 BSC |      | 0.25 BSC    |       |
| L4  | .150     | .161 | 3.80        | 4.10  |

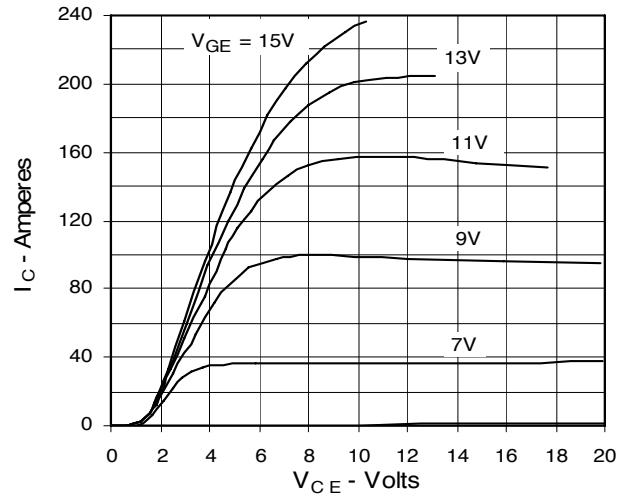
IXYS reserves the right to change limits, test conditions, and dimensions.

|  |           |           |           |           |              |              |              |              |
|--|-----------|-----------|-----------|-----------|--------------|--------------|--------------|--------------|
| IXYS MOSFETs and IGBTs are covered by one or more of the following U.S. patents: | 4,835,592 | 4,931,844 | 5,049,961 | 5,237,481 | 6,162,665    | 6,404,065 B1 | 6,683,344    | 6,727,585    |
|  | 4,850,072 | 5,017,508 | 5,063,307 | 5,381,025 | 6,259,123 B1 | 6,534,343    | 6,710,405 B2 | 6,759,692    |
|  | 4,881,106 | 5,034,796 | 5,187,117 | 5,486,715 | 6,306,728 B1 | 6,583,505    | 6,710,463    | 6,771,478 B2 |

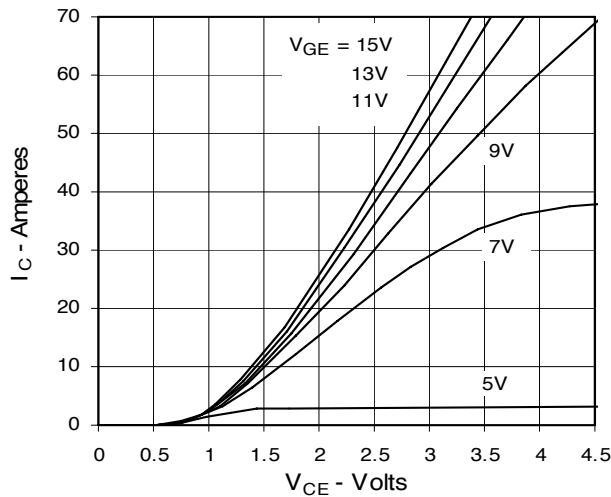
**Fig. 1. Output Characteristics**  
@ 25 °C



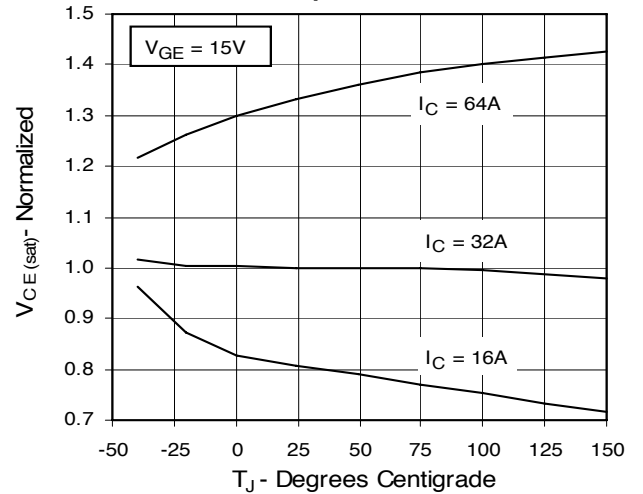
**Fig. 2. Extended Output Characteristics**  
@ 25 °C



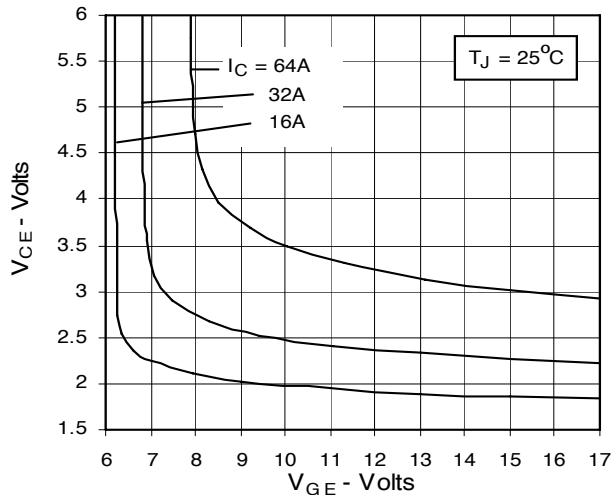
**Fig. 3. Output Characteristics**  
@ 125 °C



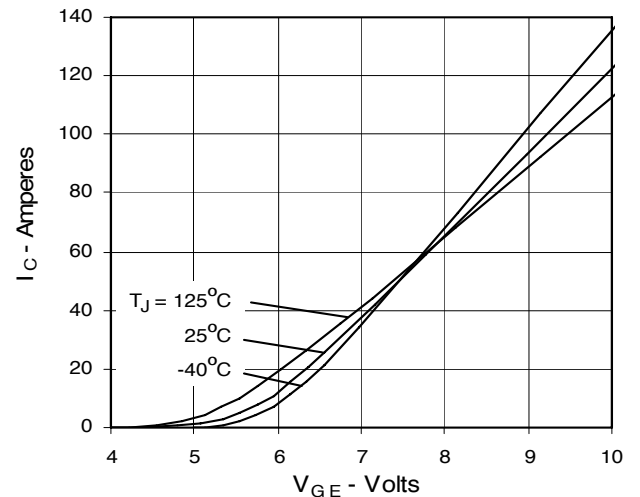
**Fig. 4. Dependence of  $V_{CE(sat)}$  on Temperature**



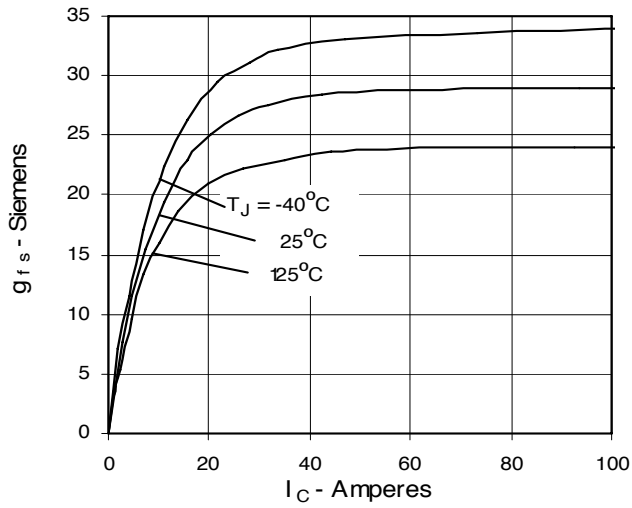
**Fig. 5. Collector-to-Emitter Voltage vs. Gate-to-Emitter voltage**



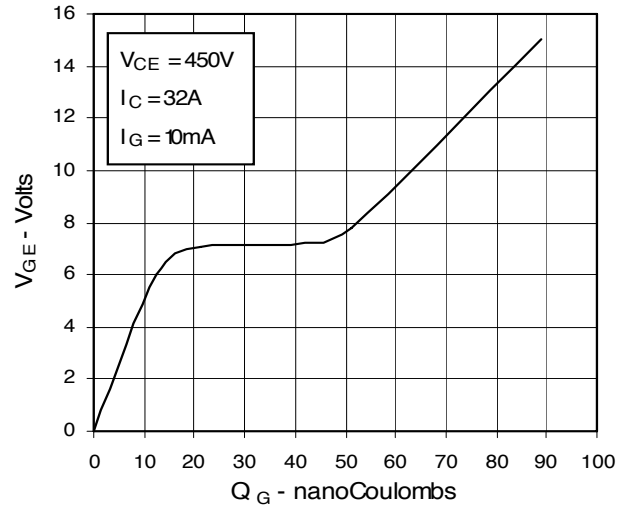
**Fig. 6. Input Admittance**



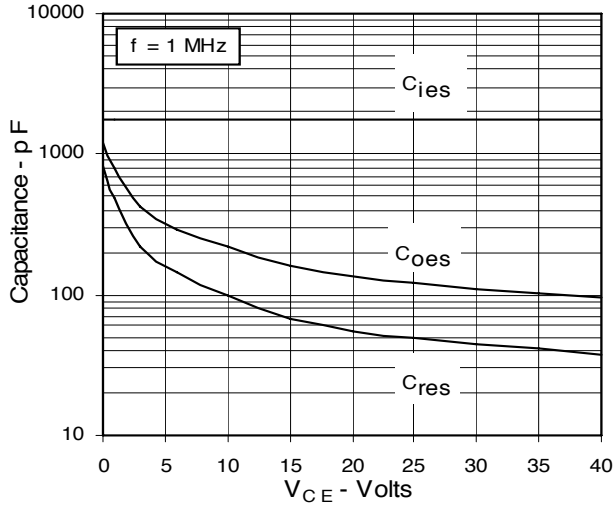
**Fig. 7. Transconductance**



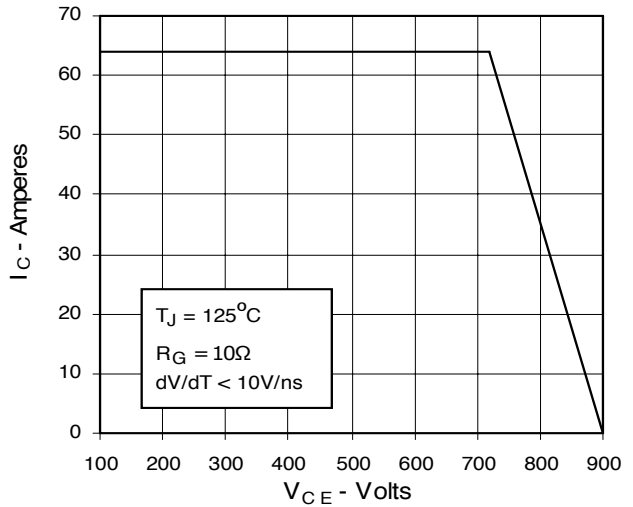
**Fig. 8. Gate Charge**



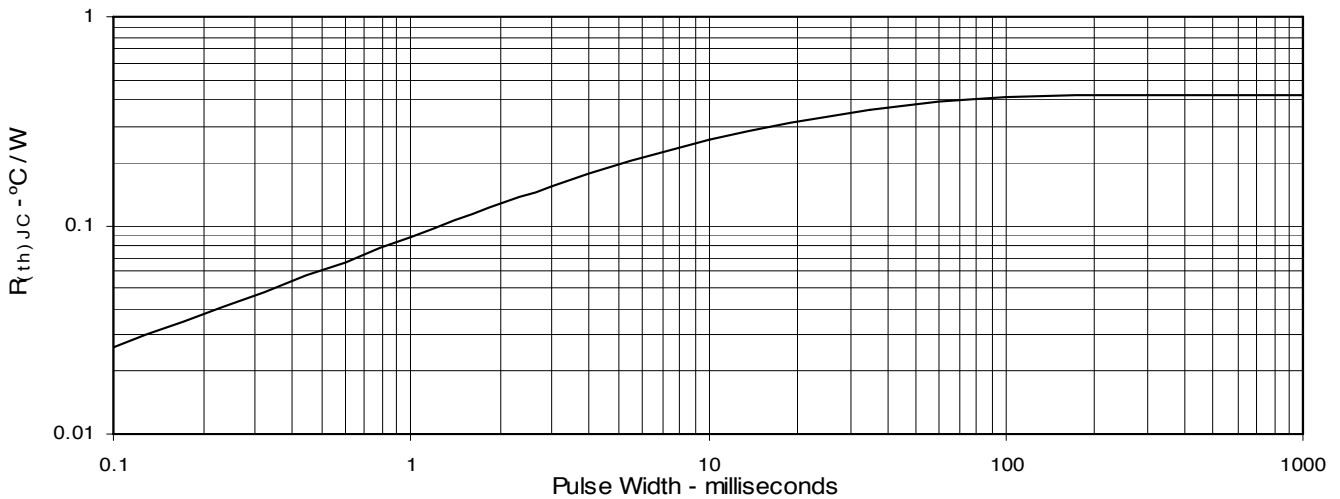
**Fig. 9. Capacitance**



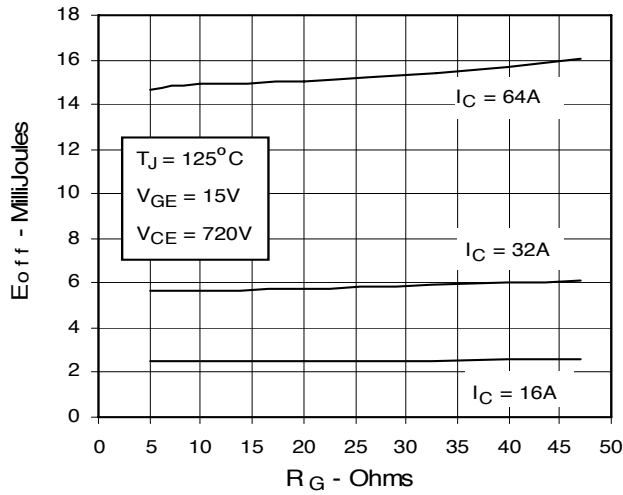
**Fig. 10. Reverse-Bias Safe Operating Area**



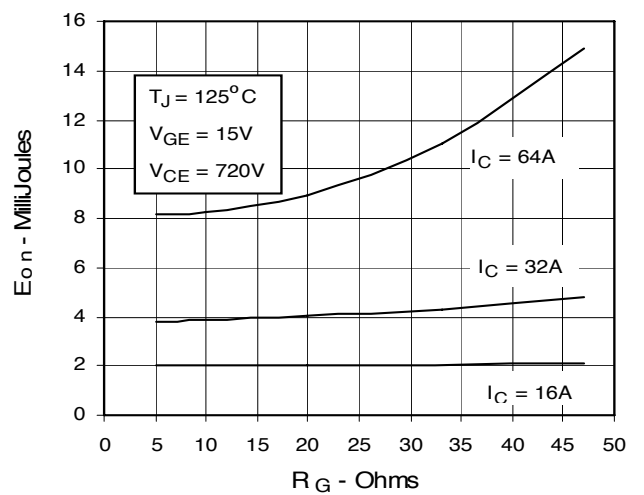
**Fig. 11. Maximum Transient Thermal Resistance**



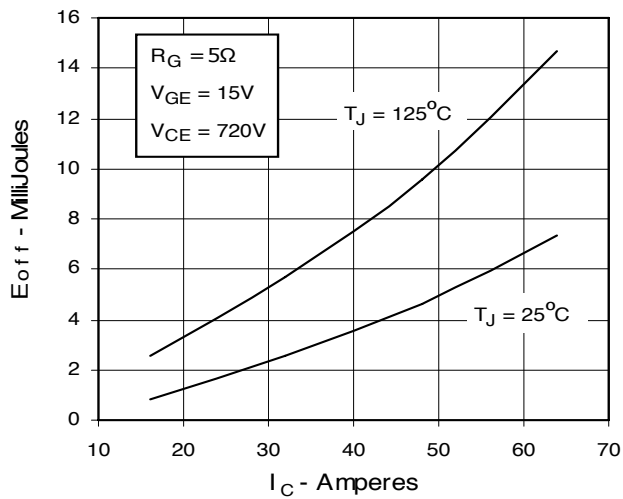
**Fig. 12. Dependence of Turn-off Energy Loss on Gate Resistance**



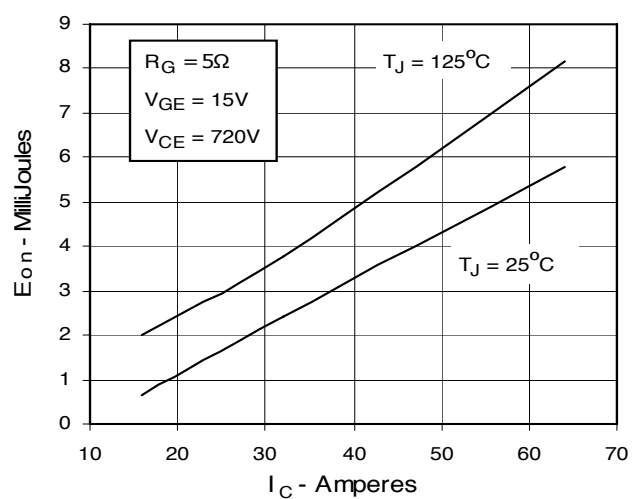
**Fig. 13. Dependence of Turn-on Energy Loss on Gate Resistance**



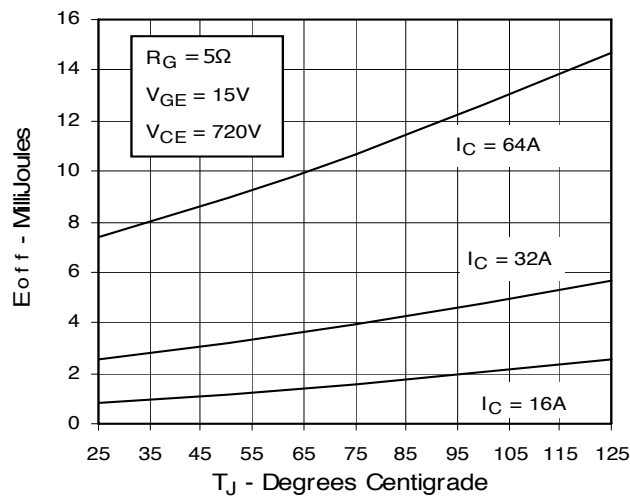
**Fig. 14. Dependence of Turn-off Energy Loss on Collector Current**



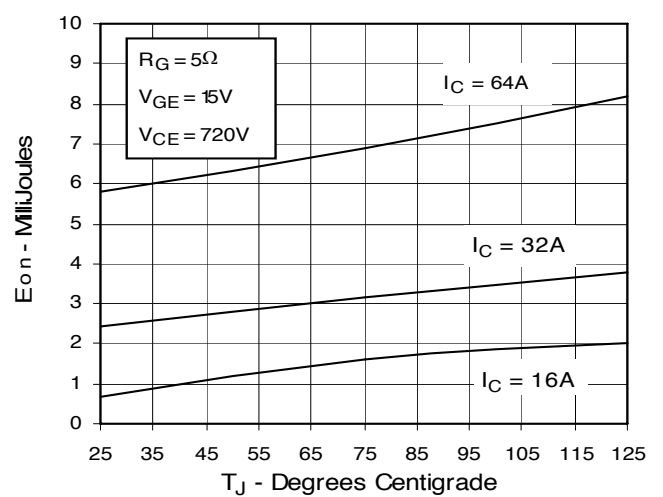
**Fig. 15. Dependence of Turn-on Energy Loss on Collector Current**



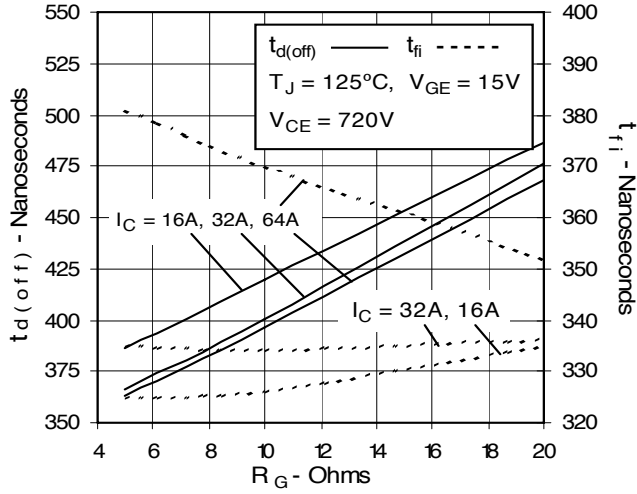
**Fig. 16. Dependence of Turn-off Energy Loss on Temperature**



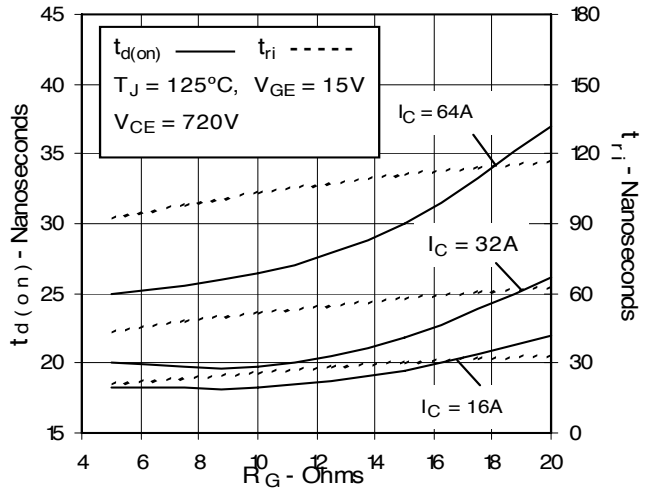
**Fig. 17. Dependence of Turn-on Energy Loss on Temperature**



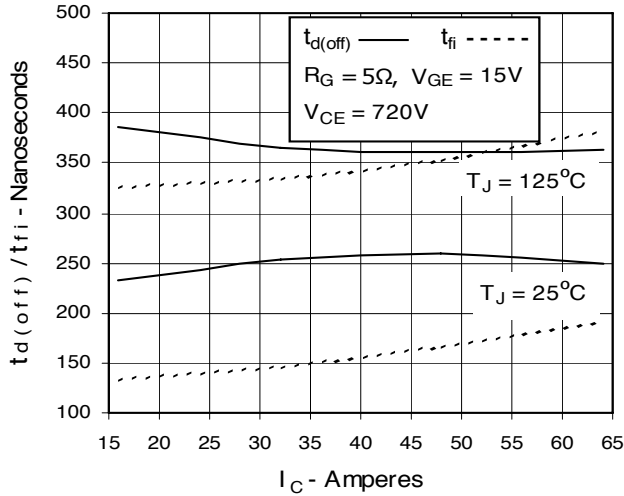
**Fig. 18. Dependence of Turn-off Switching Time on Gate Resistance**



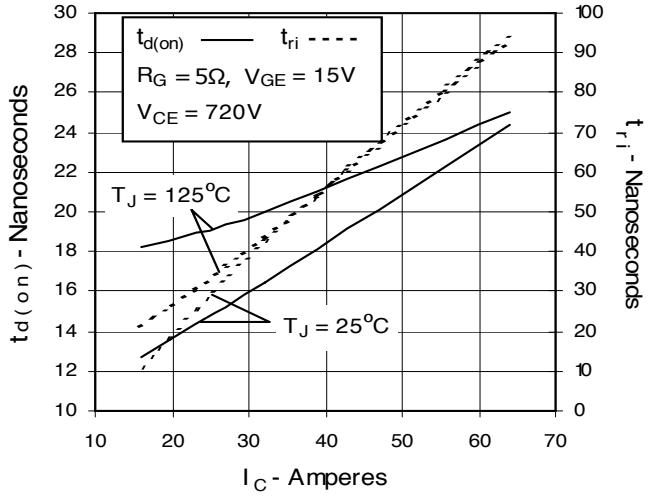
**Fig. 19. Dependence of Turn-on Switching Time on Gate Resistance**



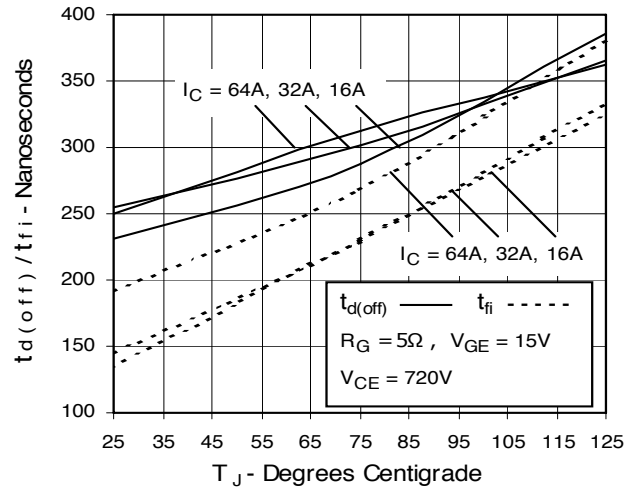
**Fig. 20. Dependence of Turn-off Switching Time on Collector Current**



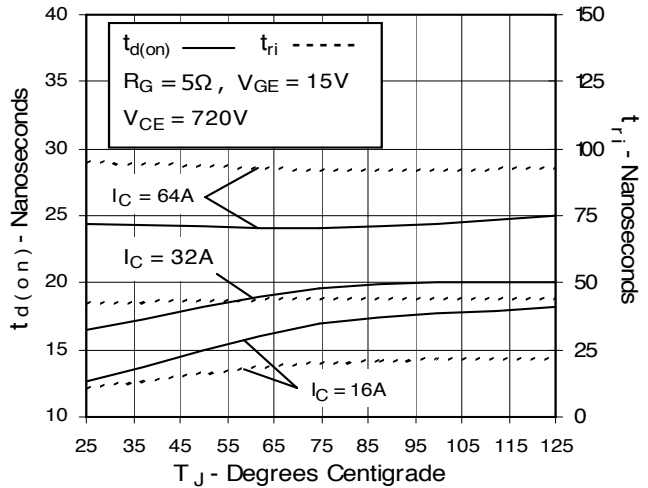
**Fig. 21. Dependence of Turn-on Switching Time on Collector Current**



**Fig. 22. Dependence of Turn-off Switching Time on Temperature**



**Fig. 23. Dependence of Turn-on Switching Time on Temperature**



**ADVANCE TECHNICAL INFORMATION**

The product presented herein is under development. The Technical Specifications offered are derived from a subjective evaluation of the design, based upon prior knowledge and experience, and constitute a "considered reflection" of the anticipated objective result. IXYS reserves the right to change limits, test conditions, and dimensions without notice.

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